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PATENT APPLICATION
Attorney's Do. No. 9903-40

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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ADRIENNE CHOCHOLAK
(SENDER'S PRINTED NAME)

(SIGNATURE)

Box Patent Application
Assistant Commissioner for Patents
Washington, D.C. 20231

Enclosed for filing is a patent application under 37 CFR 1.53(b) of:

Inventor: Hyung-Jik BYUN and Hyu-Jin LEE:
For: SEMICONDUCTOR CHIP PACKAGE COMPRISING ENHANCED
PADS

Applicant requests FIG. 5 to be published with the application.

Enclosures:

- ☒ Specification (pages 1-7); claims (pages 8-11); abstract (page 12)
☒ SEVEN sheet(s) of FORMAL drawings
☒ Declaration or Combined Declaration and Power of Attorney
☒ Newly executed (original or copy)
☒ Assignment with cover sheet
Assignee Name and Address: Samsung Electronics Co., Ltd.
Suwon-city, Kyungki-do, Korea

- ☒ Certified copy of Priority Document No. 2001-5383, filed February 5, 2001
☒ Return Postcard

CLAIMS AS FILED

For	Number Filed	Number Extra	Rate	Basic Fee
Total Claims	26-20	6	x \$ 18 =	\$740
Independent Claims	4-3	1	x \$ 84 =	\$84
TOTAL FILING FEE				\$922



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PATENT TRADEMARK OFFICE

Respectfully submitted,

MARGER JOHNSON & McCOLLOM, P.C.

Alan T. McCollom
Reg. No. 28,881

MARGER JOHNSON & McCOLLOM, P.C.
1030 SW Morrison Street
Portland, OR 97205
503-222-3613

10053278-011602